STL40N10F7



N-channel 100 V, 0.020 Ω typ., 10 A, STripFET™ VII DeepGATE™ Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - preliminary data

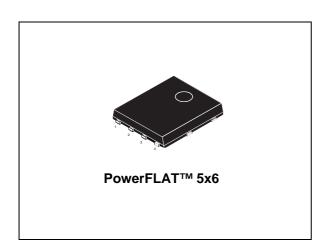
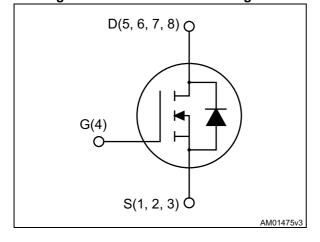


Figure 1. Internal schematic diagram



Features

Order code	V_{DS}	R _{DS(on)} max	I _D	P _{TOT}
STL40N10F7	100 V	$0.024~\Omega$	20 A	5 W ⁽¹⁾

- 1. The value is rated according R_{thi-pcb}
- Ultra low on-resistance
- 100% avalanche tested

Applications

Switching applications

Description

This device is an N-channel Power MOSFET developed using the 7th generation of STripFETTM DeepGATETM technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R_{DS(on)} in all packages.

Table 1. Device summary

Order code	Marking	Package	Packaging
STL40N10F7	40N10F7	PowerFLAT™ 5x6	Tape and reel

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STL40N10F7 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	100	V
V _{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	40	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	28	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 25 °C	10	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} =100 °C	7	Α
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	40	Α
P _{TOT} (1)	Total dissipation at T _C = 25 °C	70	W
P _{TOT} (2)	Total dissipation at T _{pcb} = 25 °C	5	W
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 175	°C

^{1.} This value is rated according to R_{thj-c.}

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	2.08	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	31	°C/W

^{1.} When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 sec

^{2.} This value is rated according to R_{thj-pcb.}

^{3.} Pulse width limited by safe operating area.

Electrical characteristics STL40N10F7

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 250 \mu A$	100			٧
	Zero gate voltage	$V_{GS} = 0, V_{DS} = 100 \text{ V}$			10	μΑ
I _{DSS}	drain current	V _{GS} = 0, V _{DS} = 100 V, T _C =125 °C			100	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0, V _{GS} = +20 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 10 A		0.02	0.024	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1320	-	pF
C _{oss}	Output capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	230	-	pF
C _{rss}	Reverse transfer capacitance		-	8	-	pF
Qg	Total gate charge	V _{DD} = 50 V, I _D = 20 A,	1	14	1	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	TBD	-	nC
Q_{gd}	Gate-drain charge	(see Figure 3)	-	TBD	1	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 50 \text{ V}, I_D = 10 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	TBD	-	ns
t _r	Rise time		-	TBD	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 2)	-	TBD	-	ns
t _f	Fall time	,	-	TBD	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-	-	20	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-	-	80	Α
V _{SD} (2)	Forward on voltage	$I_{SD} = 20 \text{ A}, V_{GS} = 0$	-	-		V
t _{rr}	Reverse recovery time	00 4 17/14 400 4/	-	-		ns
Q _{rr}	Reverse recovery charge	I _{SD} = 20 A, di/dt = 100 A/μs V _{DD} = 80 V, T _J =150 °C	-	-		nC
I _{RRM}	Reverse recovery current	י פט י, י.j=יוסט פ	-	-		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

Test circuits STL40N10F7

3 Test circuits

Figure 2. Switching times test circuit for resistive load

Figure 3. Gate charge test circuit

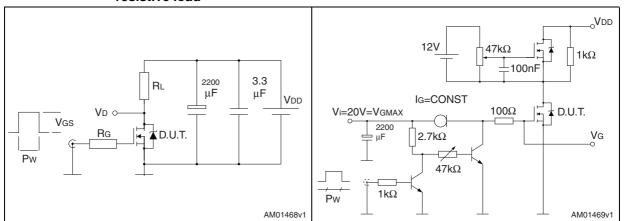


Figure 4. Test circuit for inductive load switching and diode recovery times

Figure 5. Unclamped inductive load test circuit

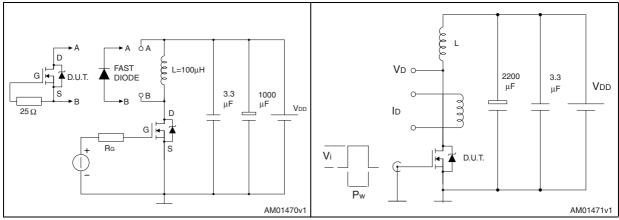
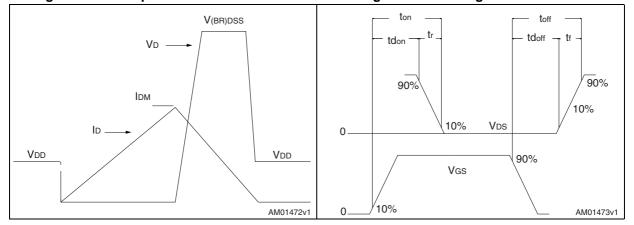


Figure 6. Unclamped inductive waveform

Figure 7. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



Table 8. PowerFLAT 5x6 type S-R mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
E	5.95	6.15	6.35
D2	4.11		4.31
E2	3.50		3.70
е		1.27	
L	0.60		0.80
K	1.275		1.575

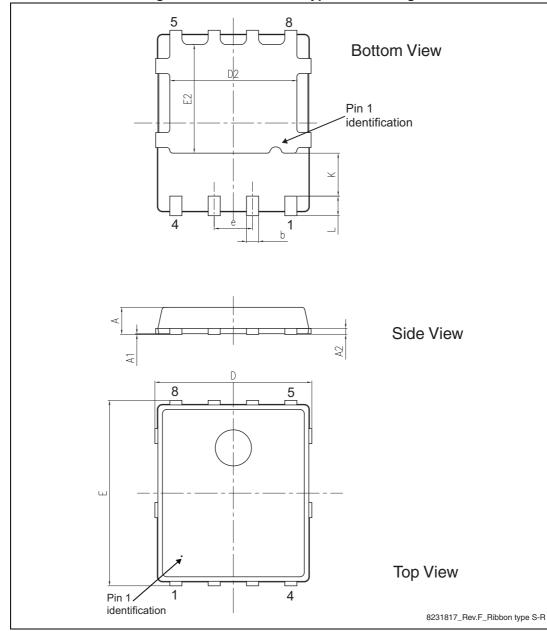


Figure 8. PowerFLAT 5x6 type S-R drawing

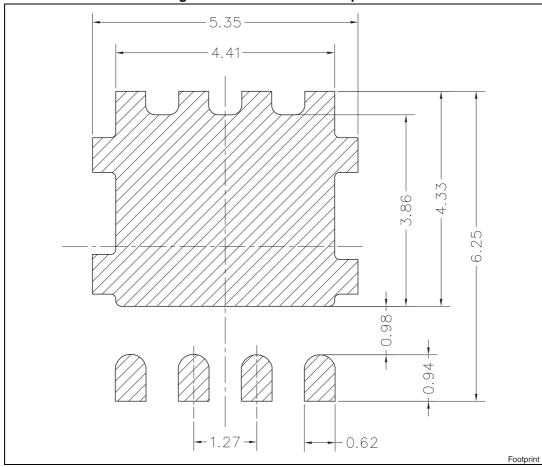


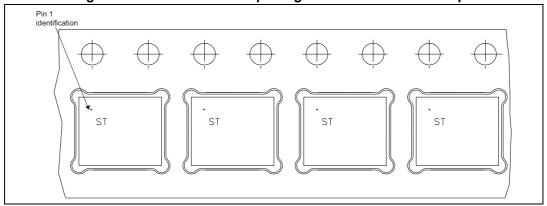
Figure 9. Recommended footprint

Packaging mechanical data 5

P₀ 4.0±0.1 (II) T (0.30±0.05) E₁ -- 1.75±0.1 Do Ø1.55±0.05 F(5.50±0.1)(III) P1(8.00±0.1) Ko (1.20±0.1) SECTION Y-Y (I) Measured from centerline of sprocket hole to centerline of pocket. Base and bulk quantity 3000 pcs (II) Cumulative tolerance of 10 sprocket holes is $\pm\ 0.20$.

Figure 10. PowerFLAT™ 5x6 tape^(a)

Figure 11. PowerFLAT™ 5x6 package orientation in carrier tape



(III) Measured from centerline of sprocket hole to centerline of pocket.

8234350_Tape_rev_C

a. All dimensions are in millimeters.

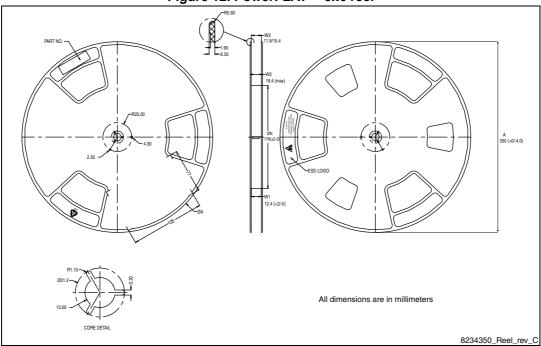


Figure 12. PowerFLAT™ 5x6 reel

STL40N10F7 Revision history

6 Revision history

Table 9. Document revision history

Date	Revision	Changes
20-May-2013	1	First release.

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